

Customer :

No. SW085105A

ALPS EUROPE DISTRIBUTION

Date : 2006 - 07 - 20

Attention :

Your ref. No. :

Your Part No. : SPUN194700

SPECIFICATION

ALPS'

SPUN194700

MODEL

Spec. No. : SPUN-S-501

Sample No. : F3290006M

RECEIPT STATUS

RECEIVED

By Date

Signature

Name

Title

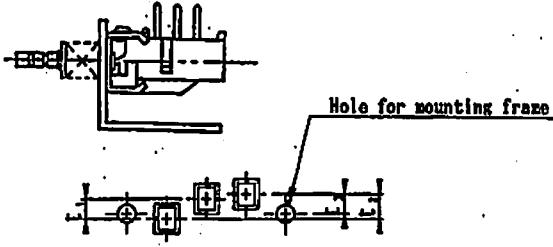
ALPS
ALPS ELECTRIC CO., LTD.

D S G' D K.
Tomita

APP' D K.ITO
ENG. DEPT. DIVISION

Sales

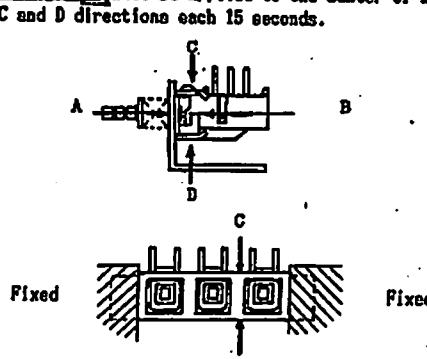
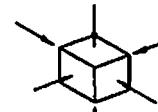
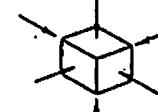
Head Office
1-7, Yukigaya-otsuka-cho, Ota-ku, Tokyo. 145-8501 Japan
Phone. +81(3)3726-1211

SPUN-S-501		SPUN PRODUCT SPECIFICATIONS						⑤									
1. General																	
1.1 Application This specification is applied to low current circuit (Secondary circuit) push switch used for electronic equipment.																	
1.2 Operating temperature range : -10 ~ 60°C																	
1.3 Test conditions The standard test conditions shall be 5~35°C in temperature, 45~85% RH and 88~106kPa (660~1000mb) in atmospheric pressure. Should any doubt arise in judgement, tests shall be conducted at 20±2°C, 65±5% RH and 88~106kPa (660~1000mb).																	
2. Appearance, construction and dimensions																	
2.1 Appearance Switch shall have good finishing, and shall have no rust, crack or plating failures.																	
2.2 Construction and dimensions Per individual product drawing																	
2.3 Markings Per individual product drawing																	
3. Rating <u>30 V DC</u> <u>0.1 A</u> (Resistive load). <u>△ Minimum rating 1 V DC 10mA</u>																	
4. Electrical performance																	
Items	Test conditions						Criterion										
4.1 Contact resistance	Shall be measured at 1kHz±200Hz (20mV MAX , 50mA MAX) or 1A, 5V DC by voltage drop method.						<u>20 mΩ MAX</u>										
4.2 Insulation resistance	Test voltage : <u>500 V DC</u> , measured after 1 minute±5 seconds. Applied position : Between all terminals Between terminals and ground (frame)						<u>100 MΩ MIN</u>										
4.3 Voltage proof	Test voltage : <u>500 V AC</u> (50~60Hz, cut-off current 2 mA) Applied position : Between all terminals Between terminals and ground (frame)						No dielectric breakdown shall occur.										
4.4 Capacitance	Shall be measured at 1MHz ± 10kHz Between all terminals Between terminals and ground (frame) Between all circuits						<u>1.5 pF MAX</u>										
4.5 Changeover timing							As per individual product drawing.										
5. Mechanical performance																	
Items	Test conditions						Criterion										
5.1 Operating force	A static load shall be applied to the tip of actuator in operating direction.						As per individual product drawing.										
5.2 Terminal strength	A static load of <u>5 N</u> (<u>510 gf</u>) shall be applied to the tip of terminal in a desired direction for 1 minute. The number of test shall be once per terminal.						Shall be free from terminal looseness and damage and breakage of terminal holding portion. Terminals may be bent after test, electrical performance requirement specified in item 4 shall be satisfied.										
5.3 Mounting strength of thread portion	Thread shall be mounted at <u>0.7 N·m</u> (<u>7.14 kgf·cm</u>) by normal mounting method.						Shall be free from damage of thread portion.										
5.4 Control strength	(1) A static load of <u>50 N</u> (<u>5.1 kgf</u>) shall be applied in the operating direction of actuator for 15 seconds. (2) A static load of <u>50 N</u> (<u>5.1 kgf</u>) shall be applied in the pull direction of actuator for 15 seconds. (For construction with lock, the test shall be conducted at the condition of lock released.) (3) A static load of <u>30 N</u> (<u>3.06 kgf</u>) shall be applied to the vertical direction of operation at the tip of actuator for 15 seconds.						Shall be free from pronounced wobble, bending and mechanical abnormalities.										
5.4.2 Lock holding strength of actuator (Applied to the switch with lock mechanism)	(1) A static load of <u>10 N</u> (<u>1.02 kgf</u>) shall be applied in the pull direction at the condition of locking actuator.						Lock shall not be dislocated. Shall be free from pronounced wobble and abnormalities in operation.										
5.5 Wobble of actuator	Run-out (P-P) shall be measured by applying a static load of <u>1N</u> (<u>0.100kgf</u>) in the vertical direction of operation at the tip of actuator.						P-P : <u>0.8 mm MAX</u> Without frame : <u>1.2mm MAX</u>										
5.6 Row of actuator (Applied to multipul-key push switch)	Switch shall be mounted as shown. Difference of sides shall be measured. 						Difference between actuators t_1 = Within <u>0.5 mm</u> Maximum difference of actuator t_2 = Within <u>0.8 mm</u> Difference between mounting hole and actuator t_3 = Within <u>0.5 mm</u>										

BACKGROUND	PAGE	SYMB	DATE	APPD	CHKD	DSGD	TITLE	
							M.	S.
ALPS ELECTRIC CO., LTD.	1/4	1/1	1994.12.12	K. I.	K. I.	F.Y	K. I.	J. Saito

(1/4)

OR

SPUN-S-501		SPUN PRODUCT SPECIFICATIONS														
Items	Test conditions	Criterion														
5.7 Mounting frame strength (Applied to multi-pul-key push switch)	Both ends of mounting frame shall be secured. A static load of <u>30 N</u> 42.06 kgf shall be applied to the center of mounting frame in A, B, C and D directions each 15 seconds. 	Warp on mounting frame shall be 0.5mm max. Shall be free from abnormalities in operation.														
5.8 Vibration	Switch shall be secured to a testing machine by a regular mounting device and method. (1) Vibration frequency range : 10~55Hz (2) Total amplitude : 1.5mm (3) Sweep ratio : 10~55~10(Hz) Approx. 1 minute (4) Method of changing the sweep vibration frequency : Logarithmic or linear (5) Direction of vibration : Three vertical directions including actuator. (6) Time : 2 hours each (6 hours in total)	Contact resistance (Item 4.1) : <u>20 mΩ MAX</u> Insulation resistance (Item 4.2) : <u>100 MΩ MIN</u> Voltage proof (Item 4.3) : Apply <u>500 V AC</u> for 1 minute. No dielectric breakdown shall occur. Operating force (Item 5.1) : Within <u>±10 %</u> of specified value. No abnormalities shall be recognized in appearance and construction.														
5.9 Mechanical shock 5.9.1 Mechanical shock	Switch shall be measured after following test. (1) Mounting method : Normal mounting method (2) Acceleration : <u>490m/s²</u> ±500 (3) Duration : <u>11ms</u> (4) Test direction : 6 directions (5) Number of shock : 3 times per direction (18 times in total) 	Contact resistance (Item 4.1) : <u>20 mΩ MAX</u> Operating force (Item 5.1) : Within <u>±10 %</u> of specified value. Shall be free from mechanical abnormalities. (Dislocation of lock of actuator shall not be regarded as abnormalities.)														
5.9.2 Lock holding shock (Applied to the switch with lock mechanism.)	Switch shall be conducted at the condition of locking actuator. (1) Acceleration : <u>147 m/s²</u> ±15 (2) Duration : <u>11 ms</u> (3) Test direction : 6 directions (4) Number of shock : 3 times per direction (18 times in total) 	Lock of actuator shall not be dislocated. Shall be free from abnormalities in operation.														
5.10 Solderability	Switch shall be checked after following test. (1) Solder : H63A (JIS Z 3282) (2) Flux : Rosin flux (JIS K 5902) having a nominal composition of 25% solids by weight of water white resin in methyl alcohol (JIS K 1501) solution. (3) Soldering temperature : <u>230±5°C</u> Immersing time : <u>3±0.5 s</u> Flux immersing time shall be 5~10 seconds in normal temperature. (4) Immersion depth : Immersion depth shall be at copper plating portion for P.C.B. terminal after mounting. Thickness of P.C. board : <u>1.6 mm</u>	More than 90% of immersed part shall be covered with solder.														
5.11 Soldering heat resistance	Switch shall be measured after following test. (1) Solder : H63A (JIS Z 3282) (2) Flux : Rosin flux (JIS K 5902) having a nominal composition of 10% solids by weight of water white resin in methyl alcohol (JIS K 1501) solution. (3) Temperature and immersing time	No abnormalities shall be recognized in appearance. The electrical performance requirements specified in Item 4 shall be satisfied.														
		<table border="1"><thead><tr><th></th><th>Temperature (°C)</th><th>Time (s)</th></tr></thead><tbody><tr><td>Dip soldering</td><td><u>280±5</u></td><td><u>10±1</u></td></tr><tr><td>Manual soldering</td><td><u>350±10</u></td><td><u>3±1</u></td></tr></tbody></table>			Temperature (°C)	Time (s)	Dip soldering	<u>280±5</u>	<u>10±1</u>	Manual soldering	<u>350±10</u>	<u>3±1</u>	APPD.	CHKD.	DSGD.	TITLE
	Temperature (°C)	Time (s)														
Dip soldering	<u>280±5</u>	<u>10±1</u>														
Manual soldering	<u>350±10</u>	<u>3±1</u>														
				<i>M</i>	<i>S.</i>	<i>Jun. 4 '93</i>	DRAWING NO.									
		PAGE	SYMB	DATE	APPD	CHKD	DSGD	<i>E. Iwahashi</i> <i>J. Saito</i>								

SPUN-S-501		SPUN PRODUCT SPECIFICATIONS						
Items	Test conditions						Criterion	
	(4) Immersion depth : Immersion depth shall be at copper plating portion for P.C.B. terminal after mounting. Thickness of P.C. board (Single sided copper clad P.C.B.) : 1.6mm							
5.12	Resistance to flux (Applied to the switch for P.C. board)	Switch shall be checked after following test. (1) Equipment : Auto-dip chamber (2) Solder : H63A (JIS Z 3282) (3) Flux : Rosin flux (JIS K 5902) having a nominal composition of 25% solids by weight of water white resin in methyl alcohol (JIS K 1501) solution. (4) Temperature : $260 \pm 5^\circ\text{C}$ (5) Immersing time : 5 ± 1 s (6) Immersion depth : Immersion depth shall be at copper plating portion for P.C.B. terminal after mounting. Thickness of P.C. board : 1.6 mm						Flux shall not be risen up to contact. Shall be free from abnormalities in operation.
6. Durability								
6.1	Operating life without load	Switch shall be operated 30,000 cycles at 15~20 cycles/minute without load.						Contact resistance (Item 4.1) : <u>40 mΩ MAX</u> Insulation resistance (Item 4.2) : <u>10 MΩ MIN</u> Voltage proof (Item 4.3) : Apply <u>500 V AC</u> for 1 minute. No dielectric breakdown shall occur. Operating force (Item 5.1) : Within <u>$\pm 10\%$</u> of specified value. No abnormalities shall be recognized in appearance and construction.
6.2	Operating life with load	Switch shall be operated 10,000 cycles at 15~20 cycles/minute with <u>30 V DC 0.1 A.</u> (Resistive load)						Contact resistance (Item 4.1) : <u>40 mΩ MAX</u> Insulation resistance (Item 4.2) : <u>10 MΩ MIN</u> Voltage proof (Item 4.3) : Apply <u>500 V AC</u> for 1 minute. No dielectric breakdown shall occur. Operating force (Item 5.1) : Within <u>$\pm 10\%$</u> of specified value. No abnormalities shall be recognized in appearance and construction.
7. Weather proof								
7.1	Cold proof	After testing at $-20 \pm 2^\circ\text{C}$ for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour. Water drops shall be removed.						Contact resistance (Item 4.1) : <u>40 mΩ MAX</u> Insulation resistance (Item 4.2) : <u>10 MΩ MIN</u> Voltage proof (Item 4.3) : Apply <u>500 V AC</u> for 1 minute. No dielectric breakdown shall occur. Operating force (Item 5.1) : Within <u>$\pm 10\%$</u> of specified value. No abnormalities shall be recognized in appearance and construction.
7.2	Dry heat	After testing at $85 \pm 2^\circ\text{C}$ for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and then measurement shall be made within 1 hour.						Contact resistance (Item 4.1) : <u>40 mΩ MAX</u> Insulation resistance (Item 4.2) : <u>10 MΩ MIN</u> Voltage proof (Item 4.3) : Apply <u>500 V AC</u> for 1 minute. No dielectric breakdown shall occur. Operating force (Item 5.1) : Within <u>$\pm 10\%$</u> of specified value. No abnormalities shall be recognized in appearance and construction.

PAGE	SYMB	DATE	APPD	CHKD	DSGD	APPD	CHKD.	DSGD.	TITLE
						M. Kine	S. Ishizuka	Jun. 4'93 T. Saito	DRAWING NO. (3/4)

(Push)

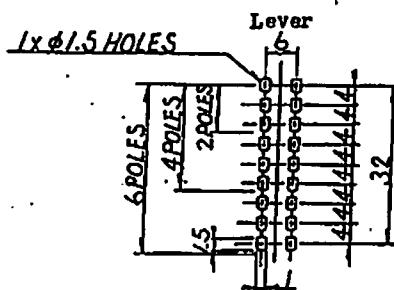
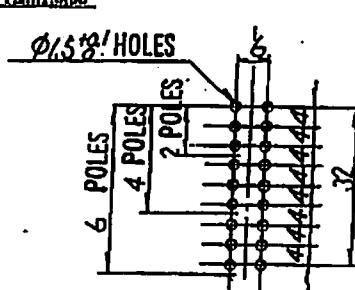
SPUN-S-501

SPUN PRODUCT SPECIFICATIONS

Items	Test conditions	Criterion
7.3 Damp heat	After testing at $40 \pm 2^\circ\text{C}$ and $90 \sim 95\%RH$ for 96 hours, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and measurement shall be made within 1 hour after that. Water drops shall be removed.	Contact resistance (Item 4.1) : <u>$40 \text{ m}\Omega \text{ MAX}$</u> Insulation resistance (Item 4.2) : <u>$10 \text{ M}\Omega \text{ MIN}$</u> Voltage proof (Item 4.3) : Apply <u>500 V AC</u> for 1 minute. No dielectric breakdown shall occur. Operating force (Item 5.1) : Within <u>$\pm 10\%$</u> of specified value. No abnormalities shall be recognized in appearance and construction.
7.4 Salt mist	Switch shall be checked after following test. (1) Temperature : $35 \pm 2^\circ\text{C}$ (2) Salt solution : $5 \pm 1\%$ (Solids by weight) (3) Duration : $24 \pm 1 \text{ h}$ After the test, salt deposit shall be removed in running water.	No remarkable corrosion shall be recognized in metal part.
7.5 Temperature cycling	After 5 cycles of following conditions, the switch shall be allowed to stand under normal temperature and humidity conditions for 1 hour, and measurement shall be made within 1 hour after that. Water drops shall be removed. 70 $\pm 2^\circ\text{C}$ Normal temperature -25 $\pm 3^\circ\text{C}$ 30 min 30 min 10~15 min 10~15 min 1 cycle	Contact resistance (Item 4.1) : <u>$40 \text{ m}\Omega \text{ MAX}$</u> Insulation resistance (Item 4.2) : <u>$10 \text{ M}\Omega \text{ MIN}$</u> Voltage proof (Item 4.3) : Apply <u>500 V AC</u> for 1 minute. No dielectric breakdown shall occur. Operating force (Item 5.1) : Within <u>$\pm 10\%$</u> of specified value. No abnormalities shall be recognized in appearance and construction.

Precaution in use

1. Note that if the lead is applied to the terminals during soldering they might suffer deformation and defects in electrical performance.
2. Use of water-soluble soldering flux shall be avoided because it may cause corrosion of the switch.
3. The knob should be mounted or demounted after single-lock releasing.
If attempted under single-locked condition, the single-acting mechanism may be damaged.
- Printed circuit board mounting hole diagram
(± 0.05 tolerance unless otherwise specified)

SNAP-IN TERMINALSSTRAIGHT TERMINALS

④ Soldering should be performed after single lock released. If attempted under single locked condition, the single-acting mechanism may be deformed by soldering heat.

						APPD.	CHKD.	DSGD.	TITLE
initial drawing	(A)	Jan 11/71		T.N.	M.	S.	Jun. 4/73		
background PAGE	SYNB	DATE	APPD	CHKD	DSGD	Kazuo Ishibashi	J. Saito	DRAWING NO.	(4)

